

AMENDMENT TO THE SPECIFICATION:

Please amend page 23, first and second paragraphs as follows:

Fig. 15 is a schematic diagram showing a wireless communication apparatus to which a sixth embodiment of the present invention is applied. As shown in the figure, the wireless communication apparatus of the present embodiment is obtained by mounting the printed circuit board shown in Fig. 1 into a chassis 1490. A radio wave absorption belt ~~1439~~ 1480 is attached to the chassis 1490 at a part under the slits 39 provided in the main circuit board 30.

According to the present embodiment, similarly to the above-described first embodiment, interference of electric field noise with the wireless communication antenna 41 can be suppressed. Further, in the present embodiment, a part of the electric field is absorbed by the radio wave absorption belt ~~1439~~ 1480 attached to the chassis 1490. Accordingly, it is possible to prevent reflection of electric field noise in the chassis 1490 and stray noise owing to coupling with the chassis 1490.

Please replace the Abstract of the Disclosure with the following paragraph:

A printed circuit board with reduced noise effects and without the need to increase the distance between a noise source and a wireless communication board. The circuit board includes multilayer structural conductive layers having a first conductive plane connected to power supply potential and a second conductive plane connected to ground potential. The first and second conductive planes are formed such that an electric field generated by a potential difference between the first conductive plane and the second conductive plane is concentrated on one side of one of the first conductive plane and the second conductive plane. The conductive plane associated with the concentrated electric field and the wireless communication board are on different sides relative to the conductive plane that is not associated with the concentrated electric field.